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U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

102075411 Tab settings ⇒⇒⇒ To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof. Name of conveying party(ies): 1. Name and address of receiving party(ies): 4-18-02 1. Achim Neu Name: Infineon Technologies AG Thies Janczek Internal Address: Patentabteilung (Additional name(s) of conveying party(ies) attached) Yes ⊠No Street Address: St.-Martin-Strasse 53 2. Nature of conveyance: City: Muenchen ☑ Assignment □ Merger State: Germany ☐ Security Agreement ☐ Change of Name Other ZIP: 81541 Execution Date: 02/26/2001 for 1, 03/12/2001 for 2. Additional name(s) & address(es) attached □Yes ☑No 4. Application number(s) or patent number(s): If this document is being filed together with a new application, the execution date of the application is B. Patent No.(s) A. Patent Application No.(s) 09/771.675 ~> Additional numbers attached ☐ Yes 図No Total number of applications and patents in volved: 5. Name and address of party to whom correspondence concerning document should be Name: Lerner and Greenberg 7. Total fee (37 CFR 3.41)\$ 40.00 Internal Address: ☑ Enclosed Street Address: P.O. Box 2480 ☐ Authorized to be charged to deposit account City: Hollywood 8. Deposit account number: State: FL (Attach duplicate copy of this page by deposit account) ZIP: 33022 DO NOT USE THIS SPACE 9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. DENISE LETTAU April 11, 2002 Name of Person Signing Date Total number of pages including cover sheet, attachments, and document: 05/41/2002 LMUELLER 90000328 09771675 40.00 DP 01 FC:581

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments
Washington, D.C. 20231

PATENT REEL: 012840 FRAME: 0490 Docket No.: GR 98 P 2153

ASSIGNMENT

WHEREAS WE, ACHIM NEU and THIES JANCZEK, residing respectively at REGENSBURG and FLINTBEK, Germany, have invented certain new and useful improvements in

INTEGRATED COMPONENT, COMPOSITE ELEMENT COMPRISING AN INTEGRATED COMPONENT AND A CONDUCTOR STRUCTURE, CHIP CARD, AND METHOD OF PRODUCING THE INTEGRATED COMPONENT

for which an application for Letters Patent of the United States of America was executed on the date of execution of this assignment;

WHÉREAS, INFINEON TECHNOLOGIES AG, a German corporation doing business at München, Germany, is desirous of acquiring the entire interest in said invention, and in any and all Letters Patent of the United States that may be obtained therefor;

NOW, THEREFORE, be it known that for and in consideration of our employment by the said corporation and other valuable consideration, the receipt and sufficiency whereof are hereby acknowledged, we have sold, assigned and transferred, and by these presents do sell, assign and transfer unto the said corporation, its legal representatives, successors and assigns, the full and exclusive right to the said invention as fully set forth and described in the above-mentioned application, and to said application and any and all divisions and continuations thereof, and any and all Letters Patent of the United States which may be granted therefor, and any and all reissues of said Letters Patent, the same to be held and enjoyed by the said corporation, its legal representatives, successors and assigns, to the full end of the term for which said Letters Patent may be granted or may be reissued or extended, as fully and entirely as the same would have been held by us had this assignment and sale not been made.

AND WE hereby authorize the Commissioner of Patents to issue any and all Letters Patent of the United States on said invention or resulting from said Application and from any and all divisions and continuations thereof to the said corporation as the assignee of the entire right, title and interest in and to the same.

IN TESTIMONY WHEREOF, we have hereunto set our hands and seals.

In the presence of:

ACHIM NEU

___(LS)

Date 26 66

JIEC JANICZEK

(LS) Date: Date:

RECORDED: 04/18/2002

PATENT REEL: 012840 FRAME: 0491